



**TISP4070M3LM THRU TISP4115M3LM,
TISP4125M3LM THRU TISP4220M3LM,
TISP4240M3LM THRU TISP4400M3LM**

BIDIRECTIONAL THYRISTOR OVERVOLTAGE PROTECTORS

TISP4xxxM3LM Overvoltage Protector Series

TISP4xxxM3LM Overview

This TISP® device series protects central office, access and customer premise equipment against overvoltages on the telecom line. The TISP4xxxM3LM is available in a wide range of voltages and has a medium current capability. These protectors have been specified mindful of the following standards and recommendations: GR-1089-CORE, FCC Part 68, UL1950, EN 60950, IEC 60950, ITU-T K.20, K.21 and K.45. The TISP4350M3LM meets the FCC Part 68 "B" ringer voltage requirement and survives the Type B impulse tests. These devices are housed in a through-hole DO-92 package (TO-92 package with cropped center leg).

Summary Electrical Characteristics

Part #	V _{DRM} V	V _(BO) V	V _T @ I _T V	I _{DRM} μA	I _(BO) mA	I _T A	I _H mA	C _o @ -2 V pF	Functionally Replaces
TISP4070M3	58	70	3	5	600	5	150	120	P0640EA
TISP4080M3	65	80	3	5	600	5	150	120	P0720EA
TISP4095M3	75	95	3	5	600	5	150	120	P0900EA
TISP4115M3	90	115	3	5	600	5	150	120	P1100EA
TISP4125M3	100	125	3	5	600	5	150	65	
TISP4145M3	120	145	3	5	600	5	150	65	P1300EA
TISP4165M3	135	165	3	5	600	5	150	65	
TISP4180M3	145	180	3	5	600	5	150	65	P1500EA
TISP4220M3	160	220	3	5	600	5	150	65	P1800EA
TISP4240M3	180	240	3	5	600	5	150	55	
TISP4250M3	190	250	3	5	600	5	150	55	P2300EA
TISP4260M3	200	260	3	5	600	5	150	55	
TISP4290M3	220	290	3	5	600	5	150	55	P2600EA
TISP4300M3	230	300	3	5	600	5	150	55	
TISP4350M3	275	350	3	5	600	5	150	55	P3100EA
TISP4395M3	320	395	3	5	600	5	150	55	P3500EA
TISP4400M3	300	400	3	5	600	5	150	55	

Bourns' part has an improved protection voltage

Summary Current Ratings

Parameter	I _{TSP} A						I _{TSM} A	di/dt A/μs
Waveshape	2/10	1.2/50, 8/20	10/160	5/320	10/560	10/1000	1 cycle 60 Hz	2/10 Wavefront
Value	300	220	120	100	75	50	32	300

*RoHS Directive 2002/95/EC Jan 27 2003 including Annex

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TISP4xxxM3LM Overvoltage Protector Series

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ITU-T K.20/21 Rating4 kV 10/700,100 A 5/310

Ion-Implanted Breakdown Region
Precise and Stable Voltage
Low Voltage Overshoot under Surge

Device	V _{DRM} V	V _(BO) V
'4070	58	70
'4080	65	80
'4095	75	95
'4115	90	115
'4125	100	125
'4145	120	145
'4165	135	165
'4180	145	180
'4220	160	220
'4240	180	240
'4250	190	250
'4260	200	260
'4290	220	290
'4300	230	300
'4350	275	350
'4395	320	395
'4400	300	400

Rated for International Surge Wave Shapes

Waveshape	Standard	I _{TSP} A
2/10 μs	GR-1089-CORE	300
8/20 μs	IEC 61000-4-5	220
10/160 μs	FCC Part 68	120
10/700 μs	ITU-T K.20/21 FCC Part 68	100
10/560 μs	FCC Part 68	75
10/1000 μs	GR-1089-CORE	50

Description

These devices are designed to limit overvoltages on the telephone line. Overvoltages are normally caused by a.c. power system or lightning flash disturbances which are induced or conducted on to the telephone line. A single device provides 2-point protection and is typically used for the protection of 2-wire telecommunication equipment (e.g. between the Ring and Tip wires for telephones and modems). Combinations of devices can be used for multi-point protection (e.g. 3-point protection between Ring, Tip and Ground).

How To Order

Device	Package	Carrier	For Standard Termination Finish Order As	For Lead Free Termination Finish Order As
TISP4xxxM3LM	Straight Lead DO-92 (LM)	Bulk Pack	TISP4xxxM3LM	TISP4xxxM3LM-S
		Tape and Reeled	TISP4xxxM3LMR	TISP4xxxM3LMR-S
	Formed Lead DO-92 (LMF)	Tape and Reeled	TISP4xxxM3LMFR	TISP4xxxM3LMFRS

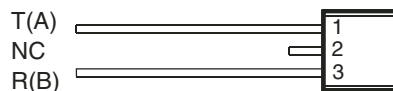
Insert xxx value corresponding to protection voltages of 070, 080, 095, 115 etc.

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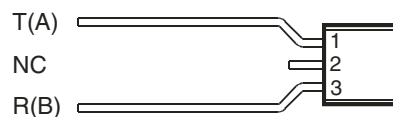
LM Package (Top View)



MD4XAT

NC - No internal connection on pin 2

LMF Package (LM Package with Formed Leads) (Top View)



MD4XAKB

NC - No internal connection on pin 2

Device Symbol



SD4XAA

Terminals T and R correspond to the alternative line designators of A and B

Low Differential Capacitance 43 pF max.



..... UL Recognized Component

TISP4xxxM3LM Overvoltage Protector Series

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Description (continued)

The protector consists of a symmetrical voltage-triggered bidirectional thyristor. Overvoltages are initially clipped by breakdown clamping until the voltage rises to the breakover level, which causes the device to crowbar into a low-voltage on state. This low-voltage on state causes the current resulting from the overvoltage to be safely diverted through the device. The high crowbar holding current prevents d.c. latchup as the diverted current subsides.

This TISP4xxxM3LM range consists of seventeen voltage variants to meet various maximum system voltage levels (58 V to 320 V). They are guaranteed to voltage limit and withstand the listed international lightning surges in both polarities. These protection devices are supplied in a DO-92 (LM) cylindrical plastic package. The TISP4xxxM3LM is a straight lead DO-92 supplied in bulk pack and on tape and reel. The TISP4xxxM3LMF is a formed lead DO-92 supplied only on tape and reel. For higher rated impulse currents in the DO-92 package, the 100 A 10/1000 TISP4xxxH3LM series is available.

Absolute Maximum Ratings, $T_A = 25^\circ\text{C}$ (Unless Otherwise Noted)

Rating	Symbol	Value	Unit
Repetitive peak off-state voltage, (see Note 1)	'4070	± 58	V
	'4080	± 65	
	'4095	± 75	
	'4115	± 90	
	'4125	±100	
	'4145	±120	
	'4165	±135	
	'4180	±145	
	'4220	±160	
	'4240	±180	
	'4250	±190	
	'4260	±200	
	'4290	±220	
	'4300	±230	
	'4350	±275	
	'4395	±320	
	'4400	±300	
Non-repetitive peak on-state pulse current (see Notes 2, 3 and 4)	I_{TSP}	300	A
2/10 μs (GR-1089-CORE, 2/10 μs voltage wave shape)			
8/20 μs (IEC 61000-4-5, combination wave generator, 1.2/50 voltage, 8/20 current)			
10/160 μs (FCC Part 68, 10/160 μs voltage wave shape)			
5/200 μs (VDE 0433, 10/700 μs voltage wave shape)			
0.2/310 μs (I 31-24, 0.5/700 μs voltage wave shape)			
5/310 μs (ITU-T K.20/21, 10/700 μs voltage wave shape)			
5/310 μs (FTZ R12, 10/700 μs voltage wave shape)			
5/320 μs (FCC Part 68, 9/720 μs voltage wave shape)			
10/560 μs (FCC Part 68, 10/560 μs voltage wave shape)			
10/1000 μs (GR-1089-CORE, 10/1000 μs voltage wave shape)			
Non-repetitive peak on-state current (see Notes 2, 3 and 5)	I_{TSM}	30	A
20 ms (50 Hz) full sine wave		32	
16.7 ms (60 Hz) full sine wave		2.1	
1000 s 50 Hz/60 Hz a.c.			
Initial rate of rise of on-state current, Exponential current ramp, Maximum ramp value < 100 A	di_T/dt	300	A/ μs
Junction temperature	T_J	-40 to +150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-65 to +150	$^\circ\text{C}$

- NOTES: 1. See Applications Information and Figure 10 for voltage values at lower temperatures.
2. Initially the TISP4xxxM3LM must be in thermal equilibrium with $T_J = 25^\circ\text{C}$.
3. The surge may be repeated after the TISP4xxxM3LM returns to its initial conditions.
4. See Applications Information and Figure 11 for current ratings at other temperatures.
5. EIA/JESD51-2 environment and EIA/JESD51-3 PCB with standard footprint dimensions connected with 5 A rated printed wiring track widths. See Figure 8 for the current ratings at other durations. Derate current values at $-0.61\% / ^\circ\text{C}$ for ambient temperatures above 25°C

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Electrical Characteristics, $T_A = 25^\circ\text{C}$ (Unless Otherwise Noted)

Parameter	Test Conditions	Min	Typ	Max	Unit
I_{DRM} Repetitive peak off-state current	$V_D = \pm V_{\text{DRM}}$ $T_A = 25^\circ\text{C}$ $T_A = 85^\circ\text{C}$			± 5 ± 10	μA
$V_{(\text{BO})}$ Breakover voltage	$dv/dt = \pm 750 \text{ V/ms}$, $R_{\text{SOURCE}} = 300 \Omega$			± 70 ± 80 ± 95 ± 115 ± 125 ± 145 ± 165 ± 180 ± 220 ± 240 ± 250 ± 260 ± 290 ± 300 ± 350 ± 395 ± 400	V
$V_{(\text{BO})}$ Impulse breakover voltage	$dv/dt \geq \pm 1000 \text{ V}/\mu\text{s}$, Linear voltage ramp, Maximum ramp value = $\pm 500 \text{ V}$ $di/dt = \pm 20 \text{ A}/\mu\text{s}$, Linear current ramp, Maximum ramp value = $\pm 10 \text{ A}$			± 78 ± 88 ± 102 ± 122 ± 132 ± 151 ± 171 ± 186 ± 227 ± 247 ± 257 ± 267 ± 298 ± 308 ± 359 ± 405 ± 410	V
$I_{(\text{BO})}$ Breakover current	$dv/dt = \pm 750 \text{ V/ms}$, $R_{\text{SOURCE}} = 300 \Omega$	± 0.15		± 0.6	A
V_T On-state voltage	$I_T = \pm 5 \text{ A}$, $t_W = 100 \mu\text{s}$			± 3	V
I_H Holding current	$I_T = \pm 5 \text{ A}$, $di/dt = -/+ 30 \text{ mA/ms}$	± 0.15		± 0.6	A
dv/dt Critical rate of rise of off-state voltage	Linear voltage ramp, Maximum ramp value $< 0.85 V_{\text{DRM}}$	± 5			$\text{kV}/\mu\text{s}$
I_D Off-state current	$V_D = \pm 50 \text{ V}$ $T_A = 85^\circ\text{C}$			± 10	μA

TISP4xxxM3LM Overvoltage Protector Series

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Electrical Characteristics, $T_A = 25\text{ }^{\circ}\text{C}$ (Unless Otherwise Noted) (continued)

Parameter	Test Conditions	Min	Typ	Max	Unit
C_{off} Off-state capacitance	f = 100 kHz, $V_d = 1\text{ V rms}$, $V_D = 0$, 4070 thru '4115		86	110	pF
	'4125 thru '4220		60	80	
	'4240 thru '4400		54	70	
	f = 100 kHz, $V_d = 1\text{ V rms}$, $V_D = -1\text{ V}$, 4070 thru '4115		80	96	
	'4125 thru '4220		56	74	
	'4240 thru '4400		50	64	
	f = 100 kHz, $V_d = 1\text{ V rms}$, $V_D = -2\text{ V}$, 4070 thru '4115		74	90	
	'4125 thru '4220		52	70	
	'4240 thru '4400		46	60	
	f = 100 kHz, $V_d = 1\text{ V rms}$, $V_D = -50\text{ V}$, 4070 thru '4115		36	47	
	'4125 thru '4220		26	36	
	'4240 thru '4400		20	30	
	f = 100 kHz, $V_d = 1\text{ V rms}$, $V_D = -100\text{ V}$, (see Note 6) '4125 thru '4220		20	30	
	'4240 thru '4400		16	24	

NOTE 6: To avoid possible voltage clipping, the '4125 is tested with $V_D = -98\text{ V}$.

Thermal Characteristics

Parameter	Test Conditions	Min	Typ	Max	Unit
$R_{\theta JA}$ Junction to free air thermal resistance □	EIA/JESD51-3 PCB, $I_T = I_{TSM(1000)}$, $T_A = 25\text{ }^{\circ}\text{C}$, (see Note 7)			120	$^{\circ}\text{C/W}$
	265 mm x 210 mm populated line card, 4-layer PCB, $I_T = I_{TSM(1000)}$, $T_A = 25\text{ }^{\circ}\text{C}$		57		

NOTE 7: EIA/JESD51-2 environment and PCB has standard footprint dimensions connected with 5 A rated printed wiring track widths.

Parameter Measurement Information

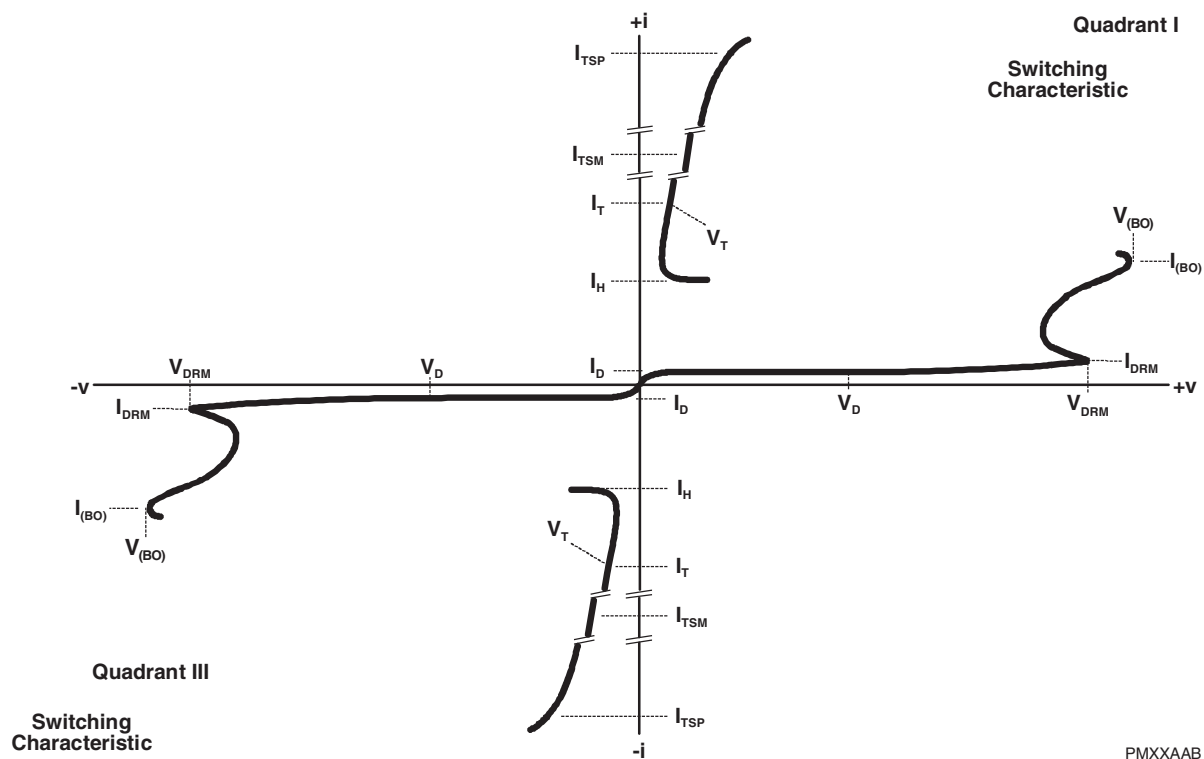


Figure 1. Voltage-current Characteristic for T and R Terminals
All Measurements are Referenced to the R Terminal

Typical Characteristics

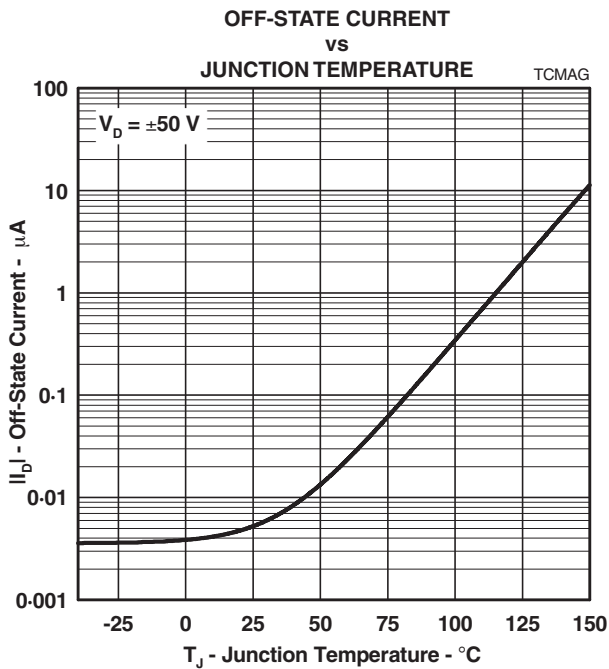


Figure 2.

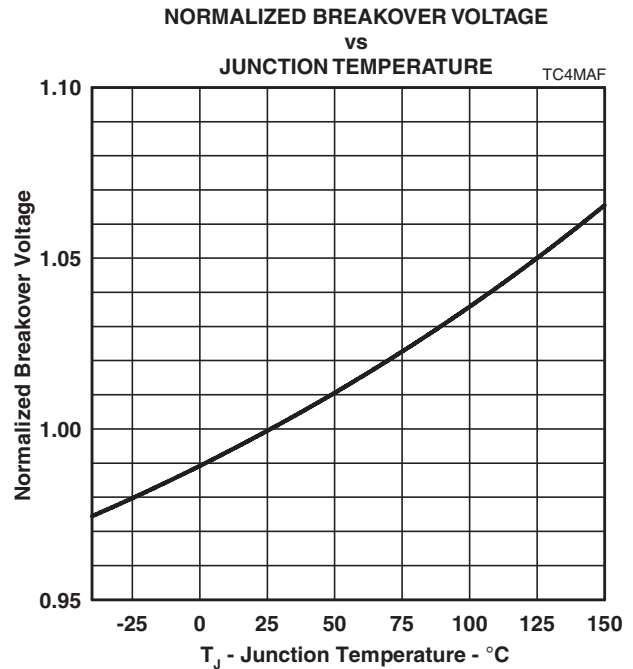


Figure 3.

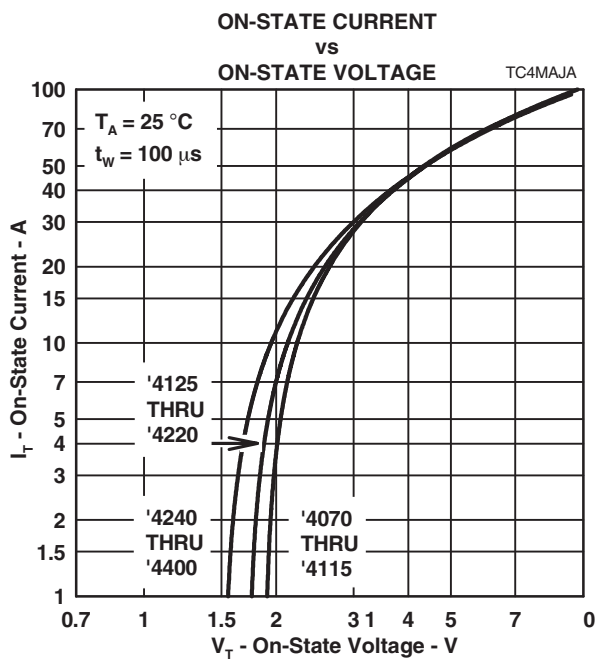


Figure 4.

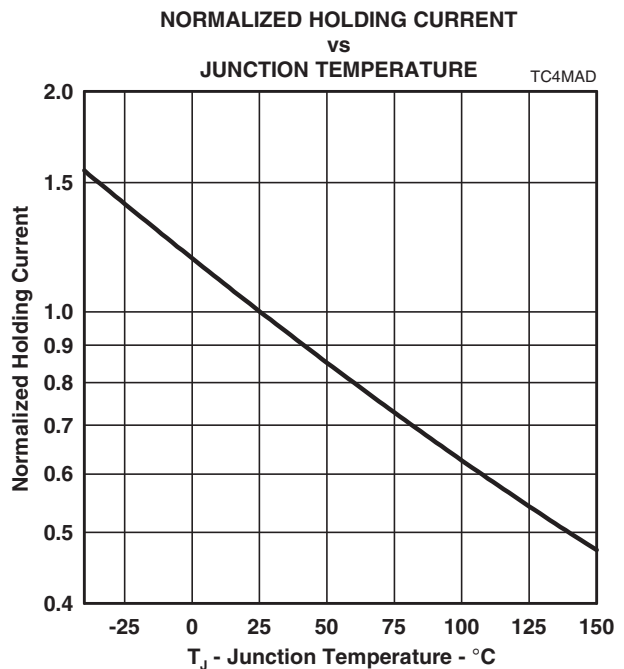


Figure 5.

Typical Characteristics

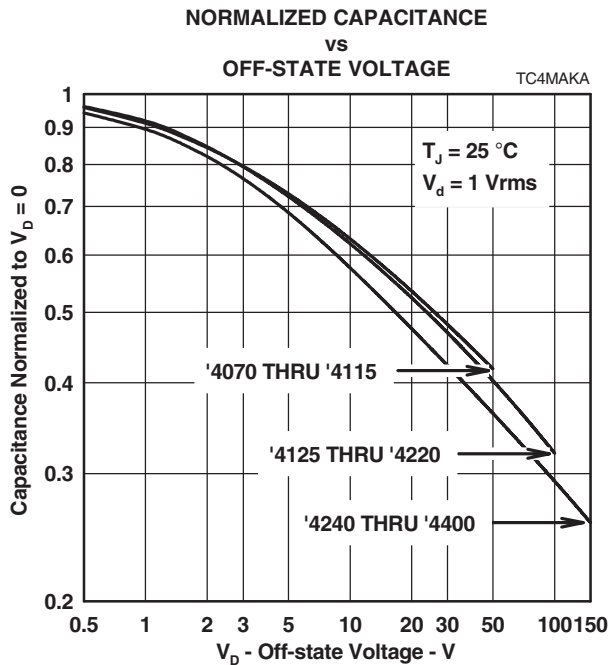


Figure 6.

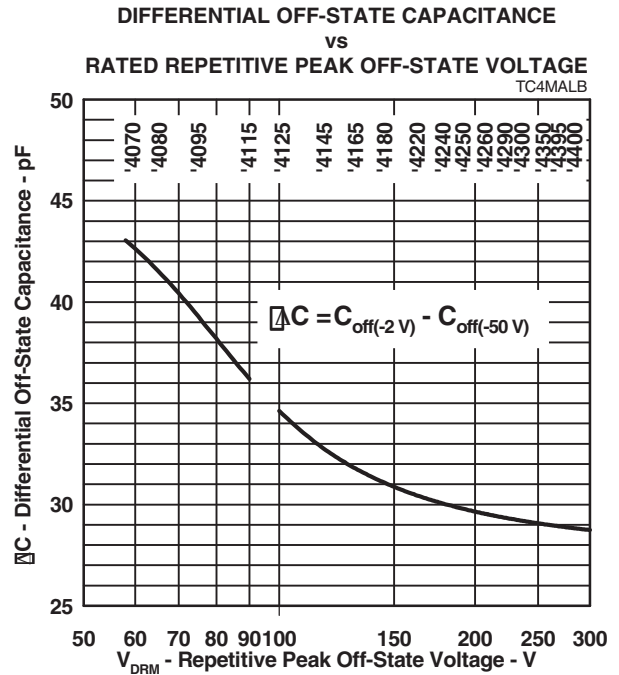


Figure 7.

Rating and Thermal Information

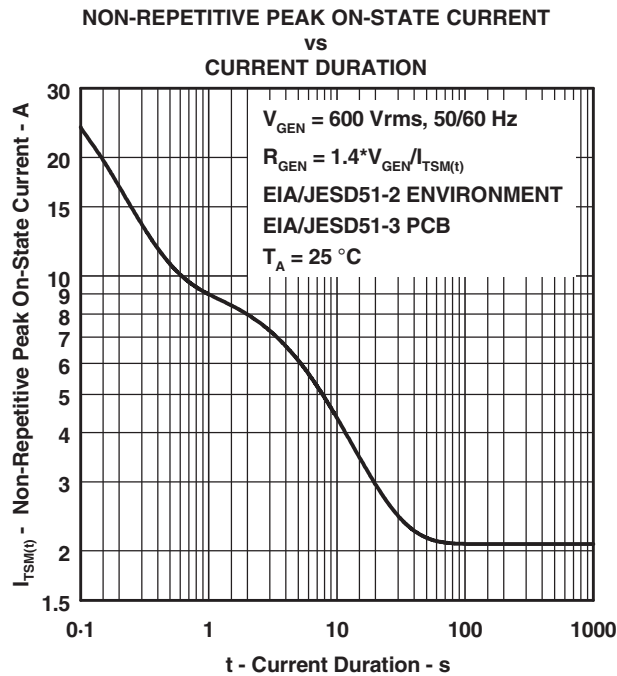


Figure 8.

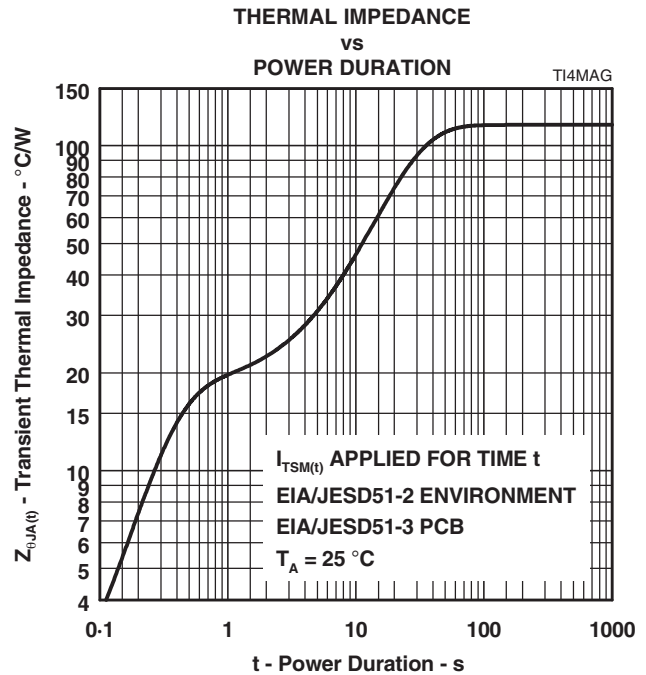


Figure 9.

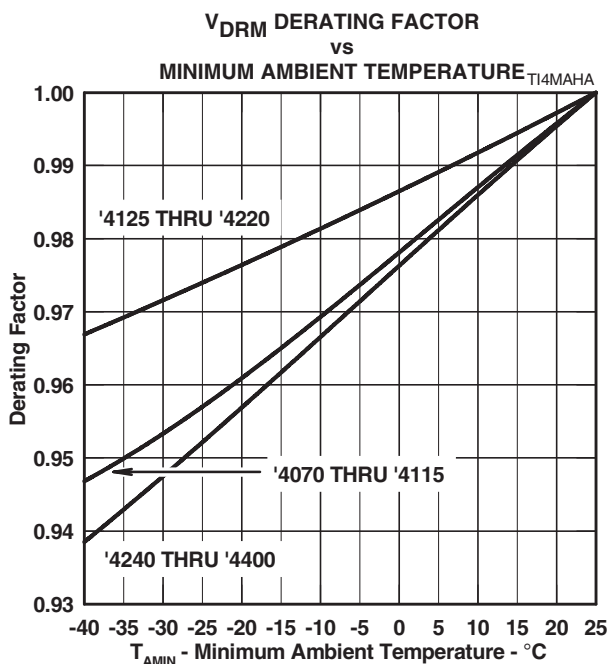


Figure 10.

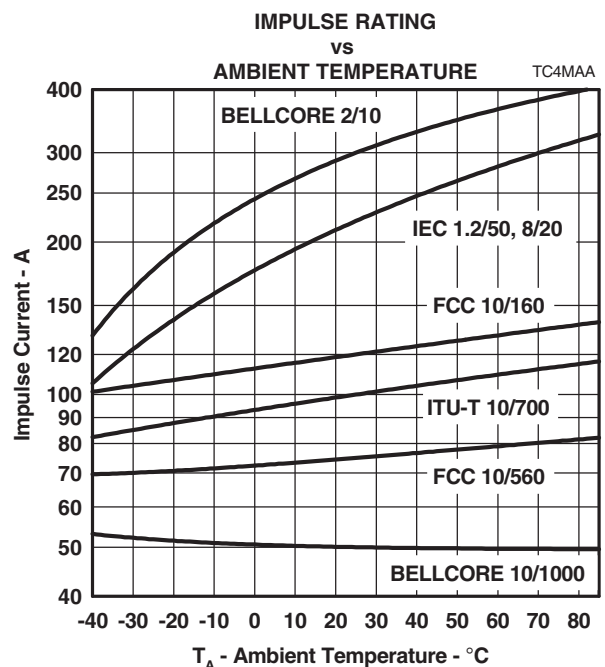


Figure 11.

APPLICATIONS INFORMATION

Deployment

These devices are two terminal overvoltage protectors. They may be used either singly to limit the voltage between two conductors (Figure 12) or in multiples to limit the voltage at several points in a circuit (Figure 13).

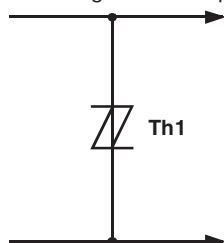


Figure 12. Two Point Protection

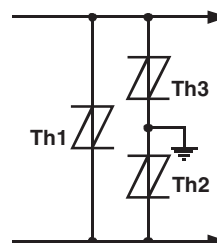


Figure 13. Multi-point Protection

In Figure 12, protector Th1 limits the maximum voltage between the two conductors to $\pm V_{(BO)}$. This configuration is normally used to protect circuits without a ground reference, such as modems. In Figure 13, protectors Th2 and Th3 limit the maximum voltage between each conductor and ground to the $\pm V_{(BO)}$ of the individual protector. Protector Th1 limits the maximum voltage between the two conductors to its $\pm V_{(BO)}$ value. If the equipment being protected has all its vulnerable components connected between the conductors and ground, then protector Th1 is not required.

Impulse Testing

To verify the withstand capability and safety of the equipment, standards require that the equipment is tested with various impulse wave forms. The table below shows some common values.

Standard	Peak Voltage Setting V	Voltage Waveform μs	Peak Current Value A	Current Waveform μs	TISP4xxxM3 25 °C Rating A	Series Resistance Ω
GR-1089-CORE	2500	2/10	500	2/10	300	11
	1000	10/1000	100	10/1000	50	
FCC Part 68 (March 1998)	1500	10/160	200	10/160	120	2x5.6
	800	10/560	100	10/560	75	3
	1500	9/720 †	37.5	5/320 †	100	0
	1000	9/720 †	25	5/320 †	100	0
I3124	1500	0.5/700	37.5	0.2/310	100	0
ITU-T K.20/K.21	1500	10/700	37.5	5/310	100	0
	4000		100			

† FCC Part 68 terminology for the waveforms produced by the ITU-T recommendation K.21 10/700 impulse generator

If the impulse generator current exceeds the protector's current rating, then a series resistance can be used to reduce the current to the protector's rated value to prevent possible failure. The required value of series resistance for a given waveform is given by the following calculations. First, the minimum total circuit impedance is found by dividing the impulse generator's peak voltage by the protector's rated current. The impulse generator's fictive impedance (generator's peak voltage divided by peak short circuit current) is then subtracted from the minimum total circuit impedance to give the required value of series resistance.

For the FCC Part 68 10/560 waveform the following values result. The minimum total circuit impedance is $800/75 = 10.7 \Omega$ and the generator's fictive impedance is $800/100 = 8 \Omega$. This gives a minimum series resistance value of $10.7 - 8 = 2.7 \Omega$. After allowing for tolerance, a $3 \Omega \pm 10\%$ resistor would be suitable. The 10/160 waveform needs a standard resistor value of 5.6 Ω per conductor. These would be R1a and R1b in Figure 15 and Figure 16. FCC Part 68 allows the equipment to be non-operational after the 10/160 (conductor to ground) and 10/560 (inter-conductor) impulses. The series resistor value may be reduced to zero to pass FCC Part 68 in a non-operational mode, e.g. Figure 14. For this type of design, the series fuse must open before the TISP4xxxM3 fails. For Figure 14, the maximum fuse i^2t is 2.3 A²s. In some cases, the equipment will require verification over a temperature range. By using the rated waveform values from Figure 11, the appropriate series resistor value can be calculated for ambient temperatures in the range of -40 °C to 85 °C.

APPLICATIONS INFORMATION

AC Power Testing

The protector can withstand currents applied for times not exceeding those shown in Figure 8. Currents that exceed these times must be terminated or reduced to avoid protector failure. Fuses, PTC (Positive Temperature Coefficient) resistors and fusible resistors are overcurrent protection devices which can be used to reduce the current flow. Protective fuses may range from a few hundred milliamperes to one ampere. In some cases, it may be necessary to add some extra series resistance to prevent the fuse from opening during impulse testing. The current versus time characteristic of the overcurrent protector must be below the line shown in Figure 8. In some cases there may be a further time limit imposed by the test standard (e.g. UL 1459 wiring simulator failure).

Capacitance

The protector characteristic off-state capacitance values are given for d.c. bias voltage, V_D , values of 0, -1 V, -2 V and -50 V. Where possible, values are also given for -100 V. Values for other voltages may be calculated by multiplying the $V_D = 0$ capacitance value by the factor given in Figure 6. Up to 10 MHz, the capacitance is essentially independent of frequency. Above 10 MHz, the effective capacitance is strongly dependent on connection inductance. In many applications, such as Figure 15 and Figure 17, the typical conductor bias voltages will be about -2 V and -50 V. Figure 7 shows the differential (line unbalance) capacitance caused by biasing one protector at -2 V and the other at -50 V.

Normal System Voltage Levels

The protector should not clip or limit the voltages that occur in normal system operation. For unusual conditions, such as ringing without the line connected, some degree of clipping is permissible. Under this condition, about 10 V of clipping is normally possible without activating the ring trip circuit.

Figure 10 allows the calculation of the protector V_{DRM} value at temperatures below 25 °C. The calculated value should not be less than the maximum normal system voltages. The TISP4260M3LM, with a V_{DRM} of 200 V, can be used for the protection of ring generators producing 100 V rms of ring on a battery voltage of -58 V (Th2 and Th3 in Figure 17). The peak ring voltage will be $58 + 1.414 \times 100 = 199.4$ V. However, this is the open circuit voltage and the connection of the line and its equipment will reduce the peak voltage. In the extreme case of an unconnected line, clipping the peak voltage to 190 V should not activate the ring trip. This level of clipping would occur at the temperature when the V_{DRM} has reduced to $190/200 = 0.95$ of its 25 °C value. Figure 10 shows that this condition will occur at an ambient temperature of -28 °C. In this example, the TISP4260M3LM will allow normal equipment operation provided that the minimum expected ambient temperature does not fall below -28 °C.

JESD51 Thermal Measurement Method

To standardize thermal measurements, the EIA (Electronic Industries Alliance) has created the JESD51 standard. Part 2 of the standard (JESD51-2, 1995) describes the test environment. This is a 0.0283 m³ (1 ft³) cube which contains the test PCB (Printed Circuit Board) horizontally mounted at the center. Part 3 of the standard (JESD51-3, 1996) defines two test PCBs for surface mount components; one for packages smaller than 27 mm (1.06 ") on a side and the other for packages up to 48 mm (1.89 "). The LM package measurements used the smaller 76.2 mm x 114.3 mm (3.0 " x 4.5 ") PCB. The JESD51-3 PCBs are designed to have low effective thermal conductivity (high thermal resistance) and represent a worse case condition. The PCBs used in the majority of applications will achieve lower values of thermal resistance and so can dissipate higher power levels than indicated by the JESD51 values.

Typical Circuits

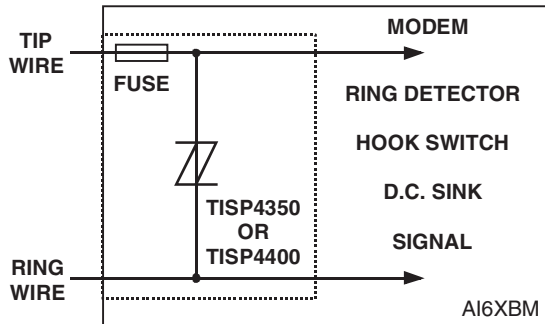


Figure 14. MODEM Inter-wire Protection

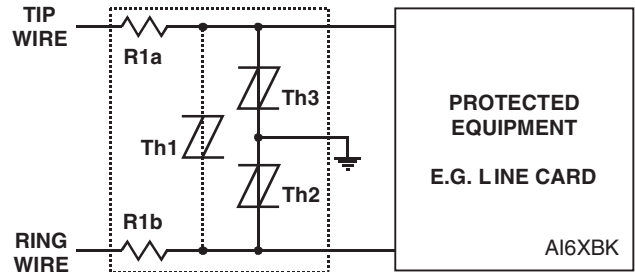


Figure 15. Protection Module

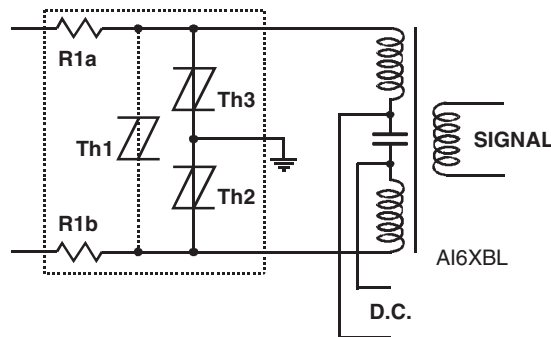


Figure 16. ISDN Protection

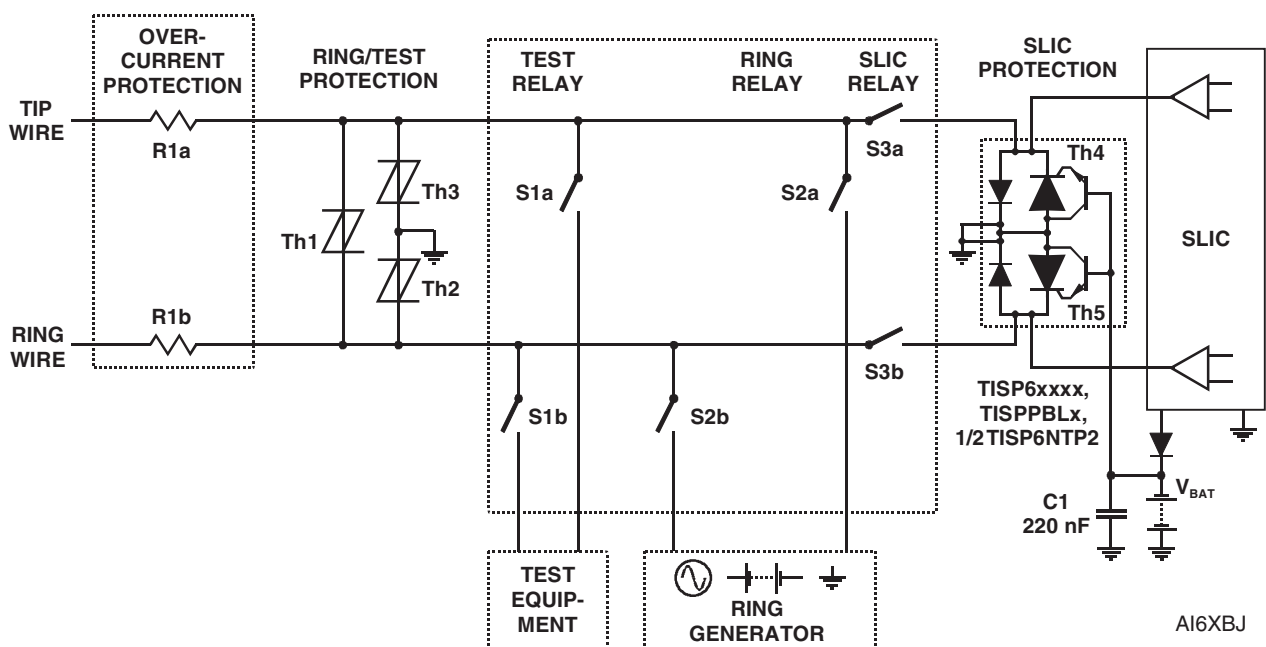


Figure 17. Line Card Ring/Test Protection

TISP4xxxM3LM Overvoltage Protector Series

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MECHANICAL DATA

Device Symbolization Code

Devices will be coded as below.

Device	Symbolization Code
TISP4070M3LM	4070M3
TISP4080M3LM	4080M3
TISP4095M3LM	4095M3
TISP4115M3LM	4115M3
TISP4125M3LM	4125M3
TISP4145M3LM	4145M3
TISP4165M3LM	4165M3
TISP4180M3LM	4180M3
TISP4220M3LM	4220M3
TISP4240M3LM	4240M3
TISP4250M3LM	4250M3
TISP4260M3LM	4260M3
TISP4290M3LM	4290M3
TISP4300M3LM	4300M3
TISP4350M3LM	4350M3
TISP4395M3LM	4395M3
TISP4400M3LM	4400M3

Carrier Information

Devices are shipped in one of the carriers below. A reel contains 2000 devices.

Package Type	Carrier	For Standard Termination Finish Order As	For Lead Free Termination Finish Order As
Straight Lead DO-92	Bulk Pack	TISP4xxxM3LM	TISP4xxxM3LM-S
Straight Lead DO-92	Tape and Reeled	TISP4xxxM3LMR	TISP4xxxM3LMR-S
Formed Lead DO-92	Tape and Reeled	TISP4xxxM3LMFR	TISP4xxxM3LMFRS

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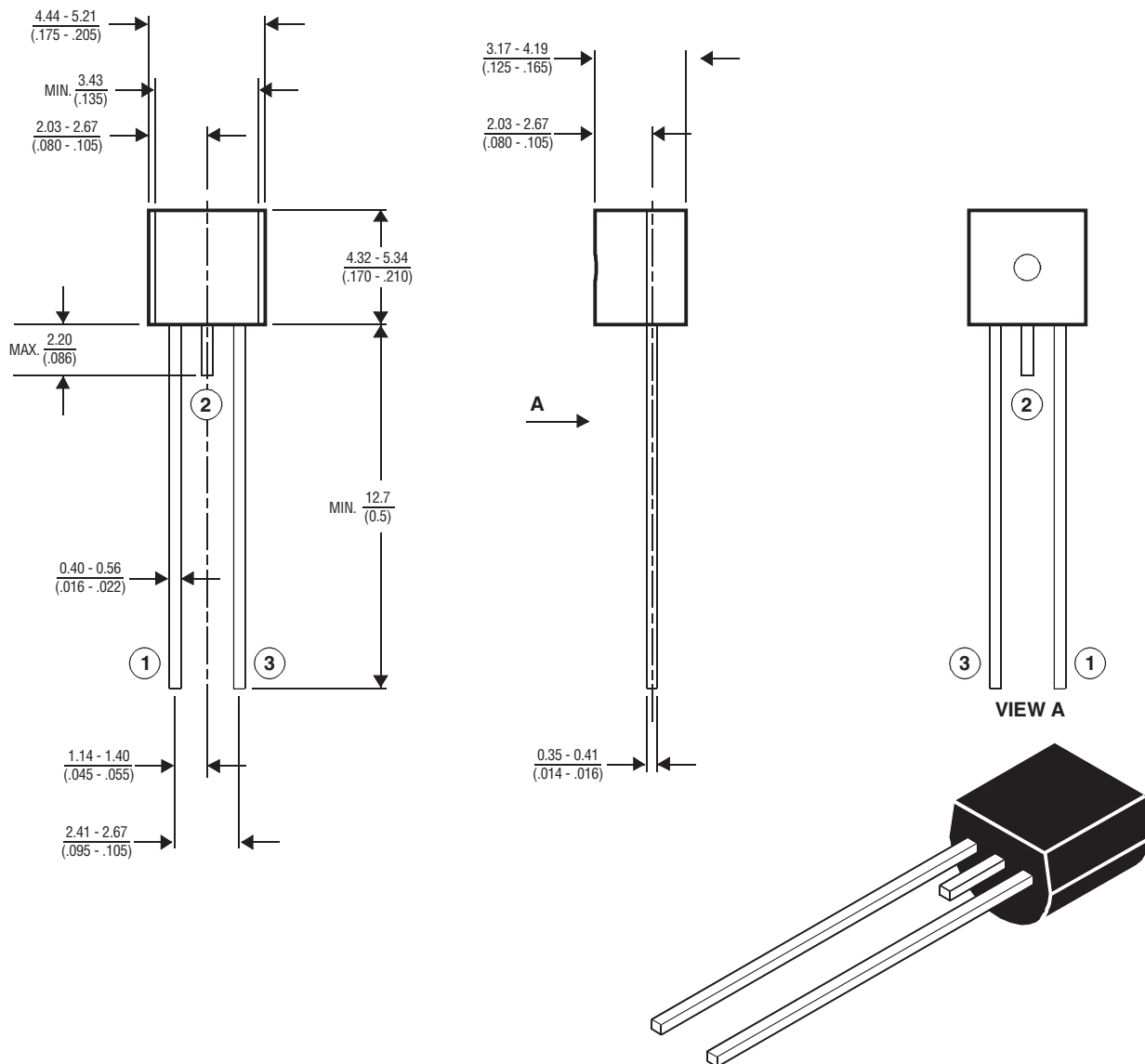
MECHANICAL DATA

LM002 (DO-92) 2-Pin Cylindrical Plastic Package

2-Pin Cylindrical Plastic Package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.

LM002 Package (DO-92)



DIMENSIONS ARE: $\frac{\text{METRIC}}{\text{(INCHES)}}$

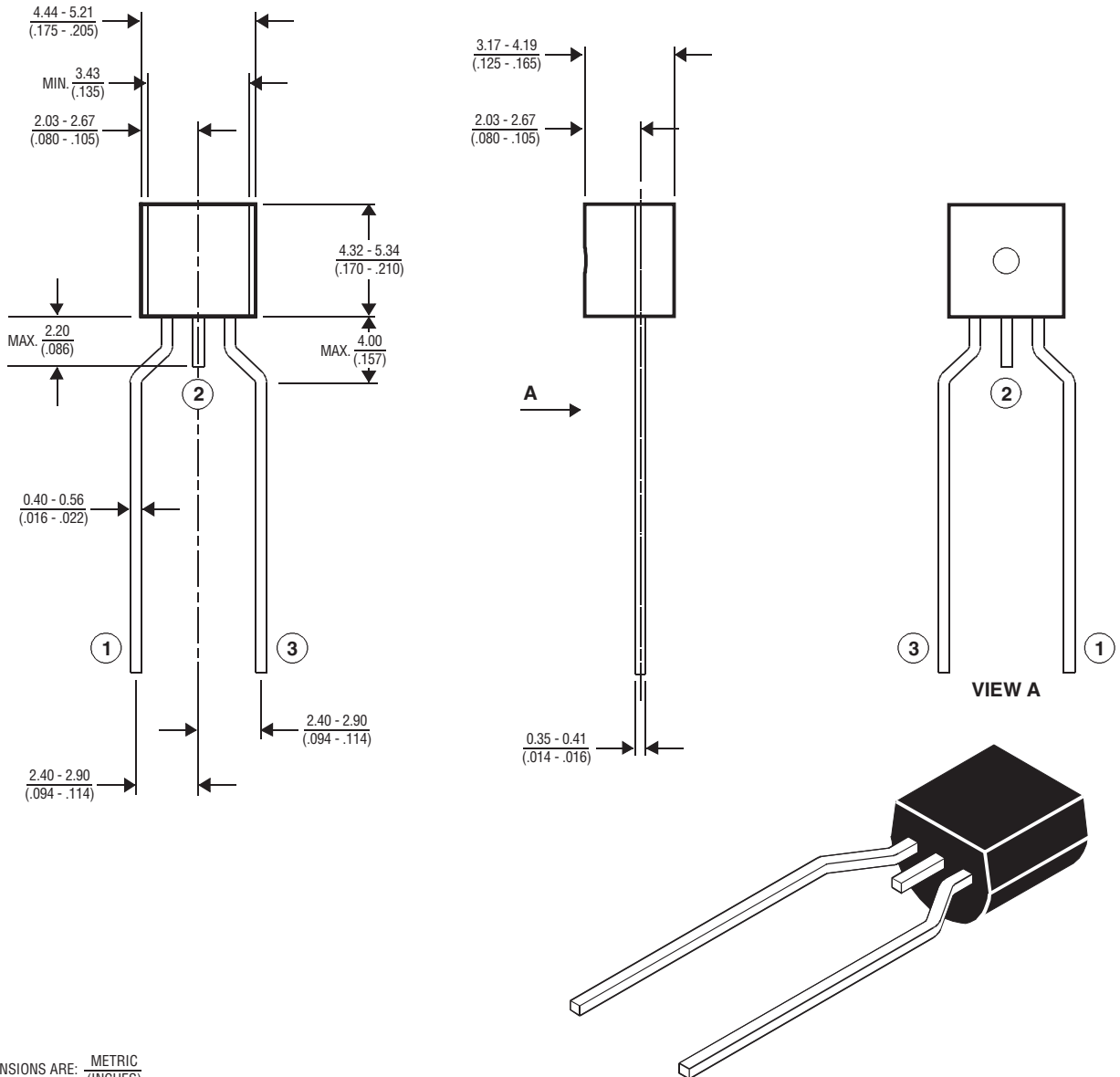
MD4XARA

MECHANICAL DATA

LM002 (DO-92) - Formed Leads Version- 2-Pin Cylindrical Plastic Package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.

LMF002 (DO-92) - Formed Leads Version of LM002



DIMENSIONS ARE: METRIC
(INCHES)

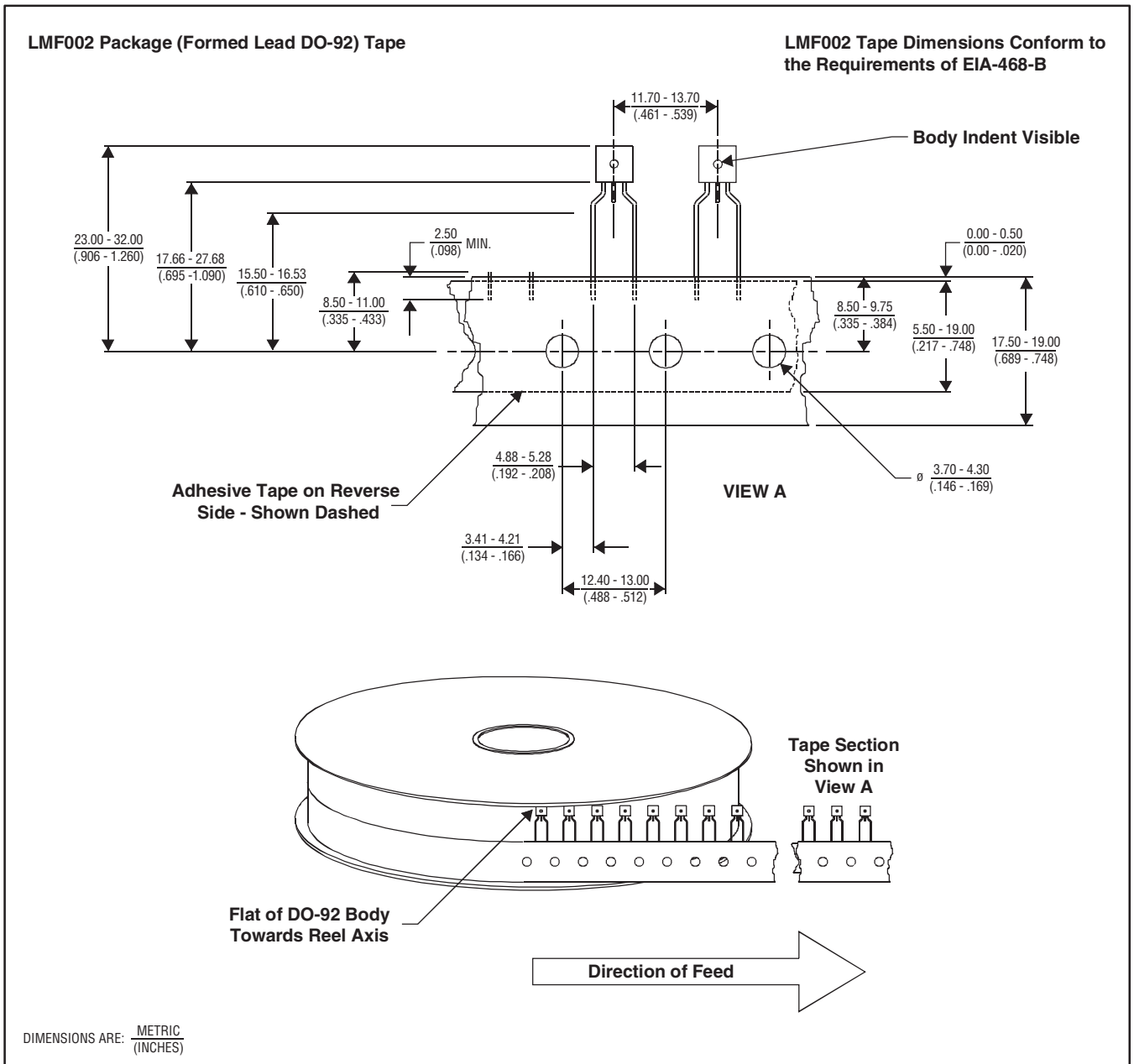
MD4XASA

TISP4xxxM3LM Overvoltage Protector Series

BOURNS®

MECHANICAL DATA

Tape Dimensions



MD4XAQC

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NOVEMBER 1997 - REVISED FEBRUARY 2005

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